imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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MBR360 is a Preferred Device

Axial Lead Rectifiers

These devices employ the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

Features

- Extremely Low v_F
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Low Stored Charge, Majority Carrier Conduction
- Pb–Free Packages are Available*

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Cathode indicated by Polarity Band

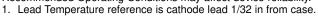
MAXIMUM RATINGS

Rating	Symbol	Мах	Unit
Peak Repetitive Reverse VoltageWorking Peak Reverse VoltageDC Blocking VoltageMBR350	V _{RRM} V _{RWM} V _R	50 60	V
Average Rectified Forward Current $T_A = 65^{\circ}C$ ($R_{\theta JA} = 28^{\circ}C/W$, P.C. Board Mounting)	Ι _Ο	3.0	A
Non-Repetitive Peak Surge Current (Note 1) (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz, $T_L = 75^{\circ}C$)	I _{FSM}	80	A
Operating and Storage Junction Temperature Range (Reverse Voltage Applied)	T _J , T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient	R _{0,JA}	28	°C/W
(see Note 4 – Mounting Data, Mounting Method 3)			

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.





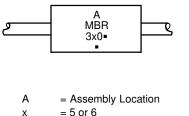
ON Semiconductor®

http://onsemi.com

SCHOTTKY BARRIER RECTIFIERS 3.0 AMPERES 50, 60 VOLTS



MARKING DIAGRAM



= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

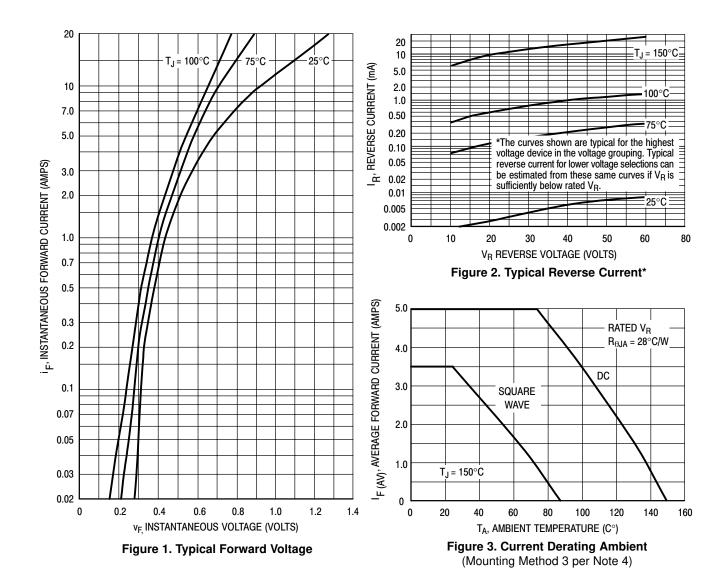
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

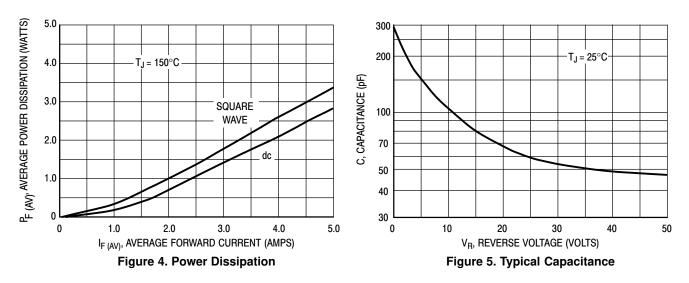
ELECTRICAL CHARACTERISTICS ($T_L = 25^{\circ}C$ unless otherwise noted) (Note 2)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 3)	٧ _F		V
$(i_{\rm F} = 1.0 \text{ Amp})$		0.600	
$(i_{\rm F} = 3.0 {\rm Amp})$		0.740	
(i _F = 9.4 Amp)		1.080	
Maximum Instantaneous Reverse Current @ Rated DC Voltage (Note 3)	i _R		mA
$T_{L} = 25^{\circ}C$		0.60	
$T_{L} = 100^{\circ}C$		20	

2. Lead Temperature reference is cathode lead 1/32 in from case.

3. Pulse Test: Pulse Width = 300 μ s, Duty Cycle = 2.0%.





NOTE 4 — MOUNTING DATA

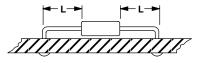
Data shown for thermal resistance, junction–to–ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

Mounting	Lead Length, L (in)			Lead Length, L (in)		
Method	1/8	1/4	1/2	3/4	$\mathbf{R}_{\theta \mathbf{JA}}$	
1	50	51	53	55	°C/W	
2	58	59	61	63	°C/W	
3		2	8		°C/W	

TYPICAL	VALUES	FOR	B O IA	IN STILL	AIR

Mounting Method 1

P.C. Board where available copper surface is small.



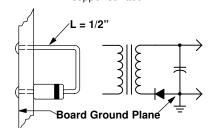
Mounting Method 2

Vector Push-In Terminals T-28

TATITI

Mounting Method 3

P.C. Board with 2–1/2 in X 2–1/2 in copper surface.



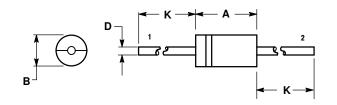
ORDERING INFORMATION

Device	Package	Shipping [†]
MBR350RL	Axial Lead	1500 Units / Tape & Reel
MBR350RLG	Axial Lead (Pb-Free)	1500 Units / Tape & Reel
MBR360	Axial Lead	500 Units / Bag
MBR360G	Axial Lead (Pb-Free)	500 Units / Bag
MBR360RL	Axial Lead	1500 Units / Tape & Reel
MBR360RLG	Axial Lead (Pb–Free)	1500 Units / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

AXIAL LEAD CASE 267–05 (DO–201AD) ISSUE G



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

MILLIMETERS INCHES MIN MAX DIM MIN MAX 0.287 0.374 7.30 A 9.50 В 0.189 0.209 4.80 5.30 D 0.047 0.051 1 20 1.30 K 1.000 --- 25.40

STYLE 1: PIN 1. CATHODE (POLARITY BAND) 2. ANODE

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